APPLICA	BLE STAN	DARD									
	Operating		55.0 / 105			rage			40.00 / 00.0		
	Temperature Range					Temperature Range Storage Humidity Range			-10 °C to 60 °	C (2)	
RATING	Voltage							je	40 % to 70 % <sup>(2)</sup>		
	Current		15A 🛕			Operating Humidity F		nge	Relative Humidity 85 <sup>o</sup>	% max	
			SPECIFICATION			10			(Not dewed)		
					ATION	S					
	EM	TEST METHOD			REQUIREMENTS				QT	AT	
CONSTRU						T					
	General Examination		Visually and by measuring instrument.				According to drawing.				×
Marking ELECTRIC CHARAC		Confirmed visually.								×	×
Contact Resistance		10 mA(DC or 1000Hz)				2 0 1	4 A V			Τ×	1
Insulation Resistance		1000 V DC.				2 mΩMAX. 1000 MΩMIN.				^   ×	$+ \equiv$
Voltage Proof		1800 V AC for 1 min.				No flashover or breakdown.				^	<del> </del>
MECHANICAL CHAR		I								1	1
Insertion and		Measured by applicable connector.				Insertion Force: 10 N MAX.				×	Ι —
Withdrawal Forces						Withdrawal Force: 0.4 N MIN.					
Mechanical Operation		100 times insertions and extractions.			① Contact Resistance: 5 m Ω MAX.				×	_	
) (1) (1)					② No damage, crack and looseness of parts.						
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				<ol> <li>No electrical discontinuity of 1 μs.</li> <li>No damage, crack and looseness of parts.</li> </ol>				×	_
Shock		490 m/s <sup>2</sup> , duration of pulse 11 ms, 3 times to both directions in 3 axial directions.								×	_
FNVIRON	MENTAL C		TERISTICS								
Damp Heat	WILLIAT AL C		at 40±2 °C, 90 ~ 95 %,	96 ±4h	١.	① Cor	tact Resis	tanc	e: 5mΩ MAX.	×	Τ-
(Steady State	e)	=						nce: 1000 MΩ MIN.			
Rapid Chang	e of	Temperature -55 → +105 °C			3 No	damage, c	rack	and looseness of parts.	×	-	
Temperature		Time	1								
		under 5 d	<b>ycles.</b> n time to chamber: within 2 <b>∼</b> 3 <b>l</b>	(IAIN)							
Dry heat		Exposed at +105±2°C for 96±4h.								×	<del> </del>
Cold		Exposed at -55±2°C for 96±4h.								×	-
Sulfur Dioxide		1 '	Exposed at 25±2°C, 75±5%RH,			① Contact Resistance: 5m Ω MAX.				×	T -
		25 PPM for 96h±4h.			② No defect such as corrosion which impairs						
Resistance to		Colder heath . Colder to represent use 200 t 5°0			the function of connector.  No deformation of case of excessive looseness				×		
Soldering Heat		Solder bath : Solder temperature 260±5°C for immersion, duration 10±1sec.			of the terminal.				^		
		Soldering irons: 380°C MAX. for 10 sec.									
			Coldoning Hono : 666 6 Nin VI. for 16 666.								
Solderability		Soldered at solder temperature 240±3°C				A new uniform coating of solder shall cover a					_
		for immersion, duration 3 sec.				minimum of 95 % of the surface being immersed.					
		1									
COUN	IT D	  ESCRIPTI	ON OF REVISIONS		DESIG	I NED			CHECKED	l DA	TE
<b>/</b> 2\ 1			S-F-007423		DK. All				KN. SHIBUYA	14. 0	
REMARKS	(1) Include temper	sture rise caused by current-carrying. s a long-term storage state product before assembly to PCB.				APPR		ED	HS. OKAWA		3. 07
	<sup>(2)</sup> "Storage" mear						CHECKE	ĒD	KI. HIROKAWA		3. 07
	for the unused					DESIGNED		FD	DK. AIMOTO	13. 03. 0	
								$\dashv$		13. 03. 07	
•			refer to JIS-C-5402,IEC60512.			DRAWN		N			ა. 0/
			AT:Assurance Test X:Applicable Test			DRAWING NO.			ELC4-350409-00		
HS			CATION SHEET		PART NO.  CODE NO.			FX30B-2P-7. 62DSA20 CL570-3104-4-00 2 1/2			
	HIF	ROSE E	LECTRIC CO., LTD.				CLS	CL570-3104-4-00 2			



